

3.2 x 1.6 x 0.9mm Red & Pure Green & Blue Chip LED

OSTB1206C1E-A

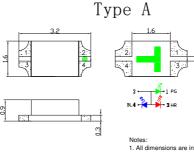
■Features

- Full-Color
- Super high brightness of surface mount LED
- Water Clear Flat Mold
- Compact package outline (LxWxT) of 3.2mm x 1.6mm x 0.9mm
- Compatible to IR reflow soldering.

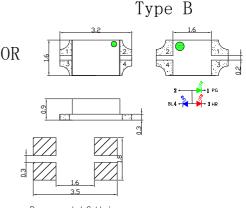
■Applications

Backlighting (switches, keys, etc.) Marker lights (e.g. steps, exit ways, etc.)

Outline Dimension



millimeters ; 2. Tolerance is ©0.10 mr



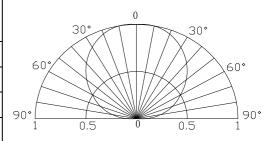
■Absolute Maximum Rating

	(1a=25	C
* *		

Item	Symbo	Val	I Init	
nem	1	R	G/B	Unit
DC Forward Current	I_F	30	30	mA
Pulse Forward Current#	I_{FP}	100	100	mA
Reverse Voltage	V_R	5	5	V
Power Dissipation	P_D	78	108	mW
Operating Temperature	Topr	-40 ~	+85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40~	$^{\circ}\!\mathbb{C}$	
Lead Soldering Temperature	Tsol	260°C /	-	

■Directivity

Pattern (Units : mm)



#Pulse width Max 0.1ms, Duty ratio max 1/10

■Electrical -Optical Characteristics

(Ta=25°C)

				$V_{F}(V)$			$I_R(\mu A)$	Iv(mcd)		λD(nm)		2θ1/2(deg)		
Part Number	Color		Min.	Тур.	Max.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Typ.	
			I _F =20mA			V _R =5V	I _F =20mA							
	Blue	В		2.8	2.9	3.6	10	100	200	-	460	466	472	120
OSTB1206C1E-A	Pure Green	G		2.8	2.9	3.6	10	400	600	-	515	520	525	120
	Red	R		1.8	2.0	2.6	10	100	200	-	615	620	625	120

^{*1} Tolerance of measurements of dominant wavelength is ±1nm

ISO 9001: 2008







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^{*2} Tolerance of measurements of luminous intensity is +15%

^{*3} Tolerance of measurements of forward voltage is±0.1V



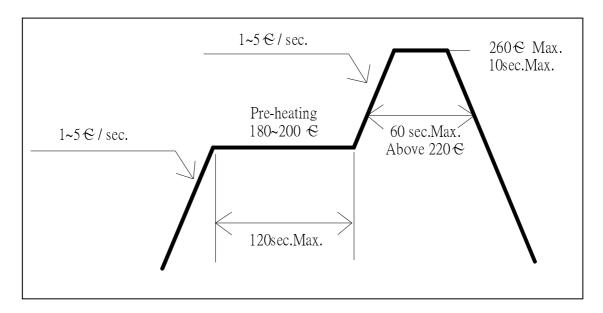
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■ Soldering Conditions

	Reflow Soldering	Har	Hand Soldering			
Pre-Heat	180 ~ 200°C					
Pre-Heat Time	120 sec. Max.					
Peak temperature	260°C Max.	Temperature	350°C Max. 3 sec. Max.			
Dipping Time	10 sec. Max.	Soldering time				
Condition	Refer to Temperature-profile		(one time only)			

• Reflow Soldering Condition(Lead-free Solder)



- *Recommended soldering conditions vary according to the type of LED
- *Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.
- *A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- •All SMD LED products are pb-free soldering available.
- Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.









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http://www.optosupply.com VER A.1.4



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■ Cautions:

- 1. After open the package, the LED's floor life is 4 Weeks under 30℃ or less and 60%RH or less(MSL:2a).
- 2. Heat generation must be taken into design consideration when using the LED.
- 3. Power must be applied resistors for protection, over current would be caused the optic damage to the devices and wavelength shift.
- 4. Manual tip solder may cause the damage to Chip devices, so advised that heat of iron should be lower than 15W with temperature control under 5 seconds at 230-260 deg. C. (The device would be got damage in re working process, recommended under 5 seconds at 230-260 deg. C)
- 5. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LED.
- 6. Use IPA as a solvent for cleaning the LED. The other solvent may dissolve the LED package and the epoxy, Ultrasonic cleaning should not be done.
- 7. Damaged LED will show unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LED get unlight at low current.







